

**Product Texts**

Polyamide 66, molding release agent, for injection molding, grey

<b>Processing/Physical Characteristics</b>	<b>dry / cond</b>	<b>Unit</b>	<b>Test Standard</b>
<b>ISO Data</b>			
<sup>[C]</sup> Molding shrinkage, parallel	<b>1.0 / *</b>	%	ISO 294-4, 2577
<sup>[C]</sup> Molding shrinkage, normal	<b>0.8 / *</b>	%	ISO 294-4, 2577

[C]: CAMPUS

<b>Mechanical properties</b>	<b>dry / cond</b>	<b>Unit</b>	<b>Test Standard</b>
<b>ISO Data</b>			
<sup>[C]</sup> Tensile Modulus	<b>3700 / 1300</b>	MPa	ISO 527
<sup>[C]</sup> Yield stress	<b>75 / -</b>	MPa	ISO 527
<sup>[C]</sup> Yield strain	<b>10 / -</b>	%	ISO 527
Flexural modulus, 23°C	<b>3200 / 1100</b>	MPa	ISO 178
Flexural strength	<b>105 / 50</b>	MPa	ISO 178
<sup>[C]</sup> Charpy impact strength, +23°C	<b>85 / -</b>	kJ/m <sup>2</sup>	ISO 179/1eU
<sup>[C]</sup> Charpy notched impact strength, +23°C	<b>4.5 / 16</b>	kJ/m <sup>2</sup>	ISO 179/1eA

[C]: CAMPUS

<b>Thermal properties</b>	<b>dry / cond</b>	<b>Unit</b>	<b>Test Standard</b>
<b>ISO Data</b>			
<sup>[C]</sup> Melting temperature, 10°C/min	<b>257 / *</b>	°C	ISO 11357-1/-3
<sup>[C]</sup> Temp. of deflection under load, 1.80 MPa	<b>60 / *</b>	°C	ISO 75-1/-2
<sup>[C]</sup> Temp. of deflection under load, 0.45 MPa	<b>200 / *</b>	°C	ISO 75-1/-2

[C]: CAMPUS

<b>Electrical properties</b>	<b>dry / cond</b>	<b>Unit</b>	<b>Test Standard</b>
<b>ISO Data</b>			
<sup>[C]</sup> Volume resistivity	<b>1E12 / -</b>	Ohm*m	IEC 62631-3-1
<sup>[C]</sup> Surface resistivity	<b>* / 1E14</b>	Ohm	IEC 62631-3-2
<sup>[C]</sup> Electric strength	<b>34 / -</b>	kV/mm	IEC 60243-1
<sup>[C]</sup> Comparative tracking index	<b>600 / -</b>	-	IEC 60112

[C]: CAMPUS

<b>Other properties</b>	<b>dry / cond</b>	<b>Unit</b>	<b>Test Standard</b>
<sup>[C]</sup> Density	<b>1160 / -</b>	kg/m <sup>3</sup>	ISO 1183

[C]: CAMPUS

**Characteristics**

**Processing**

Injection Molding

**Additives**

Release agent

**Special Characteristics**

Flame retardant, Halogen-free

**Applications**

Electrical and Electronical